

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Approved Checked Designed DEVELOPMENT SPECIFICATION A Chang Tentative P/N: LNJ806K5SUX Soft Orange Light Emitting Diode Ρ Т APPLICATION Indicators MATERIAL GaAsP OUTLINE Attached Р ፠ I_m V_R Topr Tstg ABSOLUTE ${ m I}_{ m FDC}$ -25~+85 -30**∼**+100 60 20 3 MAXIMUM 60 $^{\circ}$ C V $^{\circ}$ C mΑ RATINGS mWmΑ CONDITION | $Ta = 25 \pm 3$ °C Test Specification Limit Unit Condition Symbol | Item Typ Min Max <u>1.</u> 93 2.6 V ___ Forward Voltage $I_F = 10 \text{ mA}$ 10 $V_R = 3 V$ μ A Reverse Leakage Current ${ m I}_{ m R}$ 0.8 0.3 mcd $I_{\tau} = 10 \text{ mA} \cdot DC$ Luminous Intensity I_{o} $I_{B}=10 \text{ mA} \cdot DC$ 610 nm Peak Emission Wavelength λ <u>p</u> 40 nm I . = 10 mA · DC Spectral Line Half Width \triangle λ

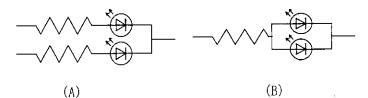
- \divideontimes · The Condition of I_{FP} is duty 10 %, Pulse width 1 ms
 - Please contact the Panasonic local office if you design at low current (below 1 mA DC) or pulse current operation and have any questions.

NOTE

- 1. Compositions of the lead ... Cu/Ni/Au plating
- 2. Soldering conditions.

Refer to Handling note.

- 3. Care should be taken that soldering is done within 3-days after opening the dry package and reel.
- 4. Package: Light yellow diffusion type.
- 5. Circuit to operate LED.



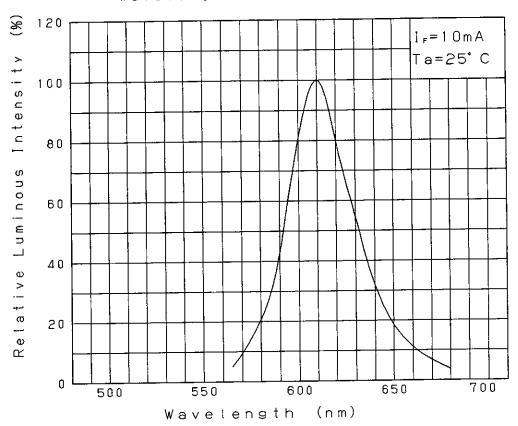
- (A) Recommended circuit.
- (B) The difference of brightness between the LED could be found due to the V_F characteristics of each LED.

Oct. 27. 2001

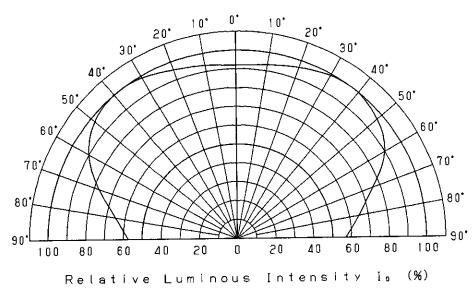
Approved	Checked	Designed	DEVELOPMENT SPECIFICATION
		K. Grang	Tentative DANIBORKSSIIX
		V.V'	P/N:LNJ806K5SUX
Forward Current	0 0 0 5 3 1 1 6	1.8 2. d Volt	Ta=25°C
Luminous Intensity Io (mcd)	0	ird Cur	I _F — Ta 25 Q E 20 1
Oct.	. 27. 20	01	
Panas	sonic	KAG	OSHIMA MATSUSHITA ELECTRONICS CO., LTD. KB-H-022-018

Approved Checked Des	igned DEVELOPMENT SPECIFICATION
K.	P/N:LNJ806K5SUX

Relative Luminous Intensity Wavelength Characteristics



Derective Characteristics



Oct.27.2001

Panasonic KAGOSHIMA MATSUSHITA ELECTRONICS CO., LTD. KB-H-022-018B

		·	
Approved		Designed Change	DEVELOPMENT SPECIFICATION (OUTLINE) P/N:
	0.5*0.1		1.9±0.2 1.7 1.7 22 23 23 24 25 25 25 25 25 25 25 25 25 25
		5°	9.0 1.0±0 0.8±0.2
	C A	THODE O	ANODE
	3.Mea get 4.Cor	t:mm erance sureme e proj ner of	unless specified is ±0.2. nt of the Package doesn't include ection. the package is R 0.2max. n's tolerance of the package is R 0.2max.

MATCHINA MATCH CHITA DI ECTENICO MITO

KR++-022-0188

Oct.27.2001